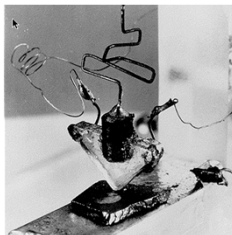


ECE4740: Digital VLSI Design

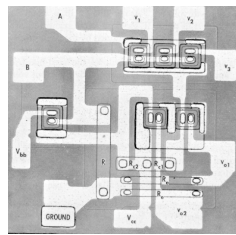
Lecture 1: Introduction

1

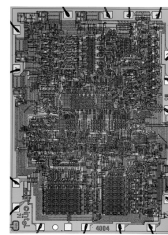
What is digital VLSI



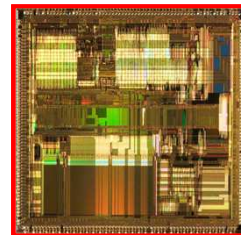
1T (1948)



6T (1960s)



1kT (1971)



1MT (1989)

- **VLSI = very large scale integration**
- Idea: Implement thousands (...I mean billions) of transistors on a single chip

Images taken from: <http://www.computerhistory.org/collections/catalog/102618871>,
http://gecko54000.free.fr/?documentations=1989-04_Intel_80486

2

First electronic computer: ENIAC

- ENIAC = Electronic Numerical Integrator And Computer

- 17,468 vacuum tubes
- Unreliable (longest period without failure: 116h)
- Excessive power (150kW)
- **Not scalable**

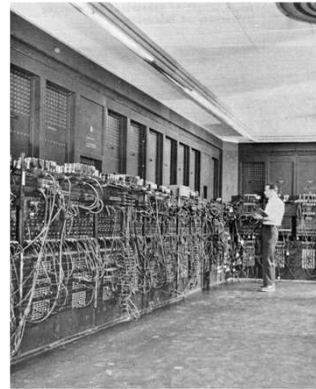


Image taken from: <http://www.internetlooks.com/oncomputers.html>

3

First computer bug

Photo # NH 96566-KN First Computer "Bug", 1945

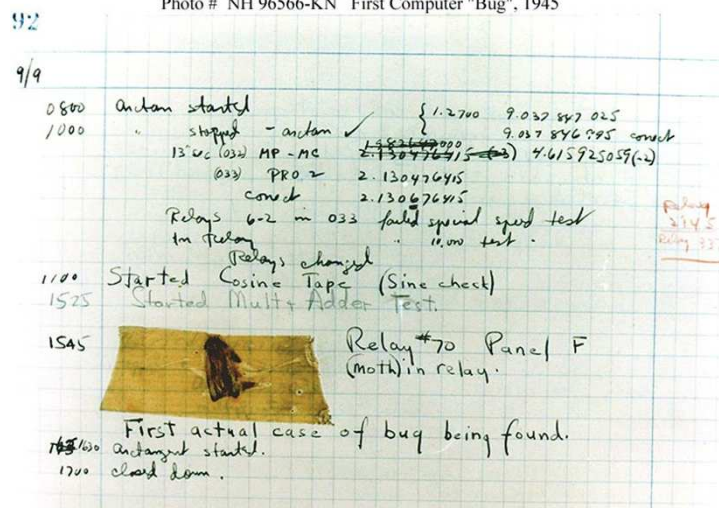
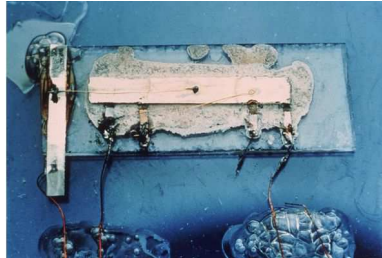


Image taken from: <http://www.ksyash.com/2011/01/178/>

4

First “integrated” circuit



- Invented by Jack Kilby in 1959 (TI)
- Simple analog oscillator on a single chip
- Received Nobel Prize
- Scalable!

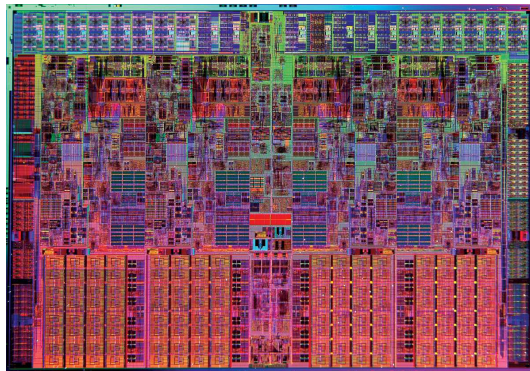
Image taken from: <https://www.pcworld.com/article/2048664/the-legend-of-jack-kilby-55-years-of-the-integrated-circuit.html>

5

Modern digital VLSI



1BT (2002)

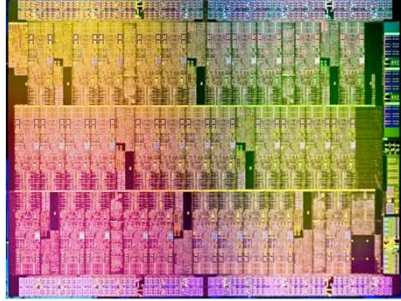


- Semiconductors account for about 0.5% of the world gross domestic product (GDP)
- Has much larger impact on world economy!

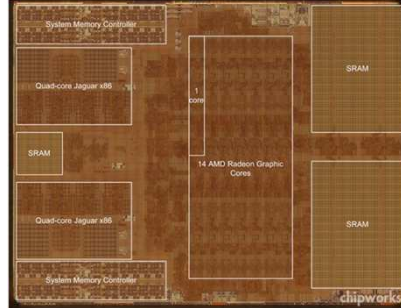
Images taken from: https://www.intel.com/pressroom/archive/releases/2008/20081117comp_sm.htm

6

Large chips



Intel Xeon Phi processor
5B T, 62-cores, 22nm

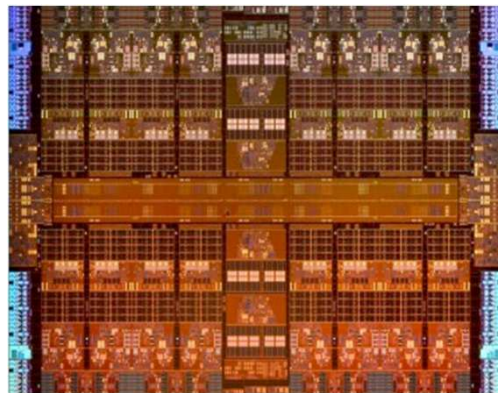


Xbox One SOC
5B T, Microsoft/AMD, 28nm

Images taken from: <https://www.extremetech.com/extreme/171678-intel-unveils-72-core-x86-knights-landing-cpu-for-exascale-supercomputing>, <https://www.extremetech.com/gaming/171735-xbox-one-apu-reverse-engineered-reveals-sram-as-the-reason-for-small-gpu>

7

Larger chips

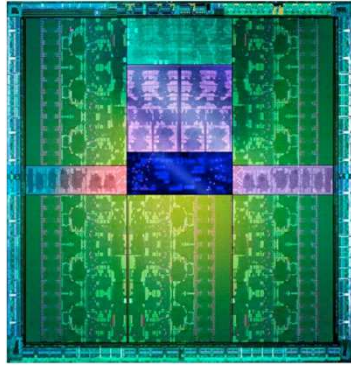


Oracle SPARC M7 processor
32 cores, about 10B T, 16nm FinFET

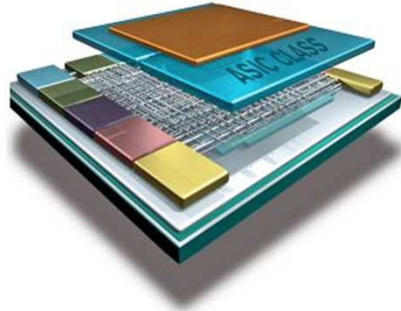
Image taken from: <https://www.enterprisetech.com/2014/08/13/oracle-cranks-cores-32-sparc-m7-chip/>

8

Even larger chips



NVIDIA Kepler GK110 GPU
7.08B T, 28nm



Xilinx Virtex Ultrascale
FPGA
+20B T, 20nm

Images taken from: <https://www.nvidia.com/content/PDF/kepler/NVIDIA-Kepler-GK110-Architecture-Whitepaper.pdf>, <https://ngcodec.com/news/2013/12/16/xilinx-pulls-back-the-20nm-ultrascale-curtain>

9

Largest chips today: Memories



Samsung 128Gb DDR4 DIMM
about 140B T, 30nm

Image taken from: https://www.tweaktown.com/news/24799/samsung_announces_16gb_ddr4_dimm_to_be_released_in_2014/index.html

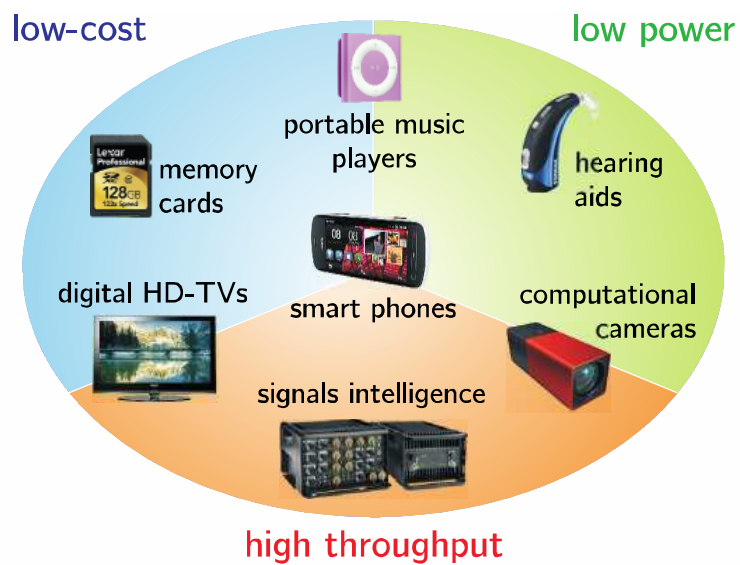
10

Do you own VLSI?

- Which devices rely on VLSI?
- What tasks are VLSI circuits doing?
- Why do you think is VLSI used?

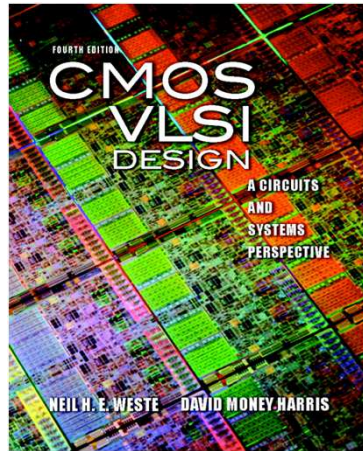
11

VLSI is (almost) everywhere!



12

Primary textbook



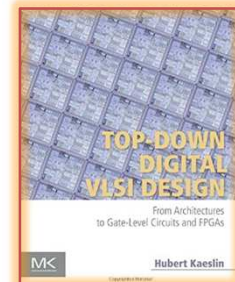
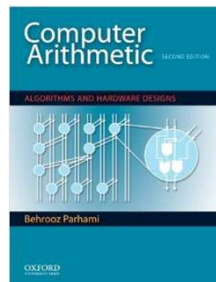
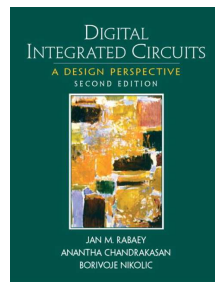
Neil E. Weste
David M. Harris

CMOS VLSI Design:
A Circuits and
Systems
Perspective

Image taken from: <http://pages.hmc.edu/harris/cmospvlsi/4e/index.html>, Pearson

15

Optional textbooks



- For those who want to learn more (details)
- For those who plan to do a PhD in VLSI

Images taken from: <https://sites.google.com/site/oftaitumo/digital-integrated-circuits-2nd-edition-5242536>, https://www.ece.ucsb.edu/~parhami/text_comp_arit.htm

16

DO NOT CHEAT!

Cornell Code of Academic Integrity:
<http://cuinfo.cornell.edu/Academic/AIC.html>

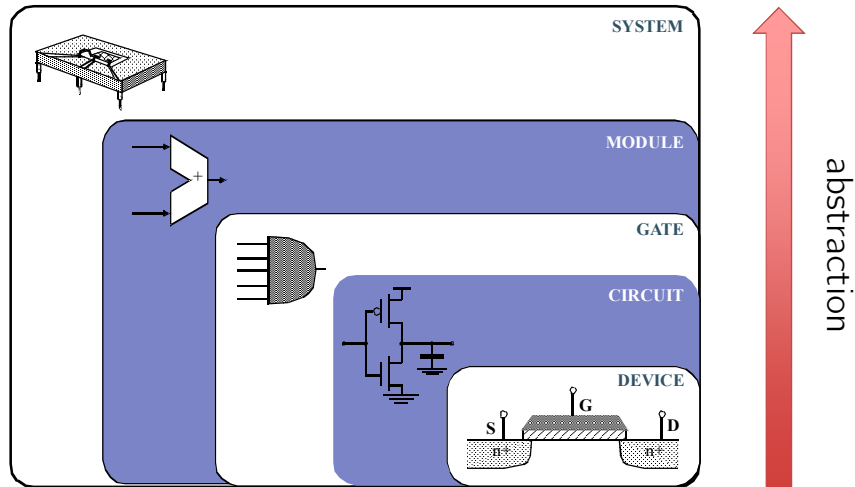
17

What is ECE4740 all about?

Course outline and goals

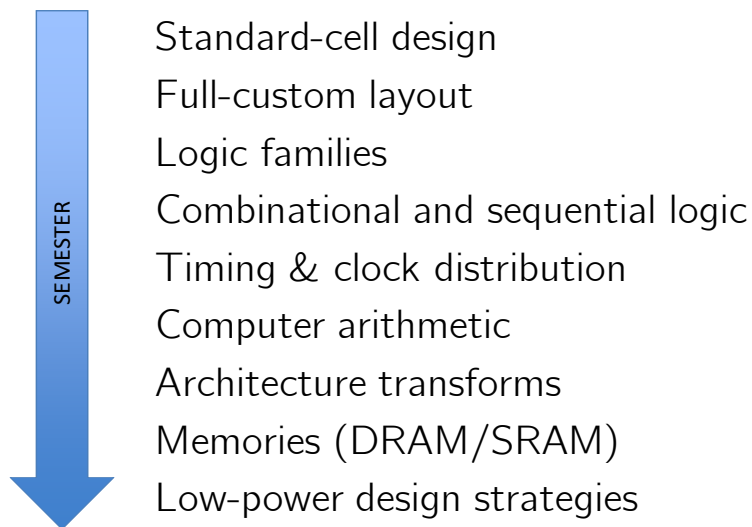
18

Course overview



19

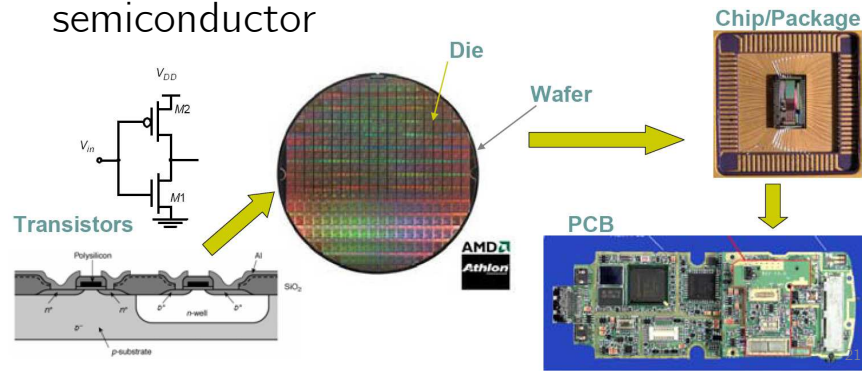
Topics covered



20

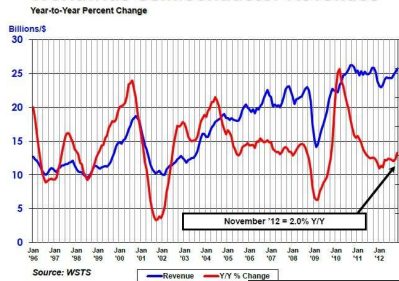
What is digital VLSI?

- Digital integrated circuits: many transistors (thousands to billions) on a single chip
- CMOS = complementary metal oxide semiconductor

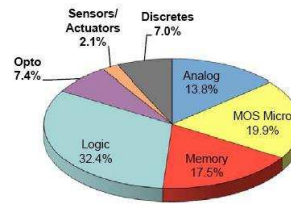


Why should I study VLSI?

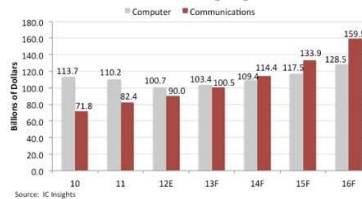
Worldwide Semiconductor Revenues



O-S-D Marketshares versus Major IC Segments
(2008 Semiconductor Market, \$261.8 Billion)



Communications Becoming Largest Market for ICs



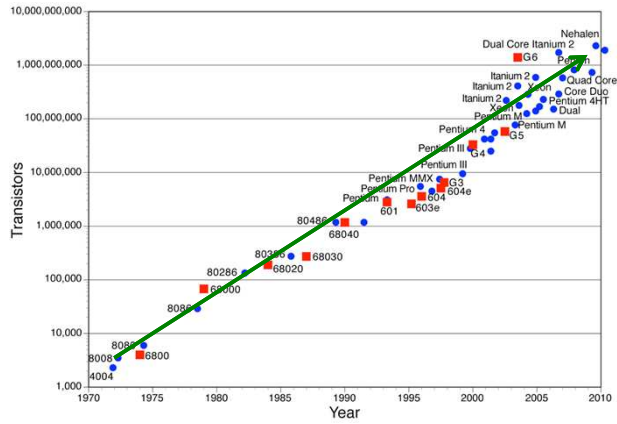
Images taken from: <https://www.forbes.com/sites/jimhandy/2014/01/15/sia-record-world-semiconductor-revenues-in-november/#5a8f0e573ed0>, <http://electroiq.com/insights-from-leading-edge/2012/11/>

Moore's Law (1965)

- # of transistors doubles every 18 months



Gordon Moore

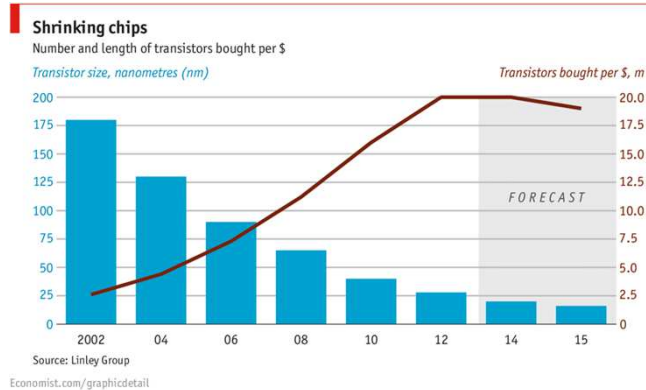


Images taken from: <http://entrepreneurhalloffame.com/gordon-moore/>, <https://cielotech.wordpress.com/2016/06/10/moores-law/>

23

Will Moore's Law end?

- 10nm with standard silicon technology seems to be the end*

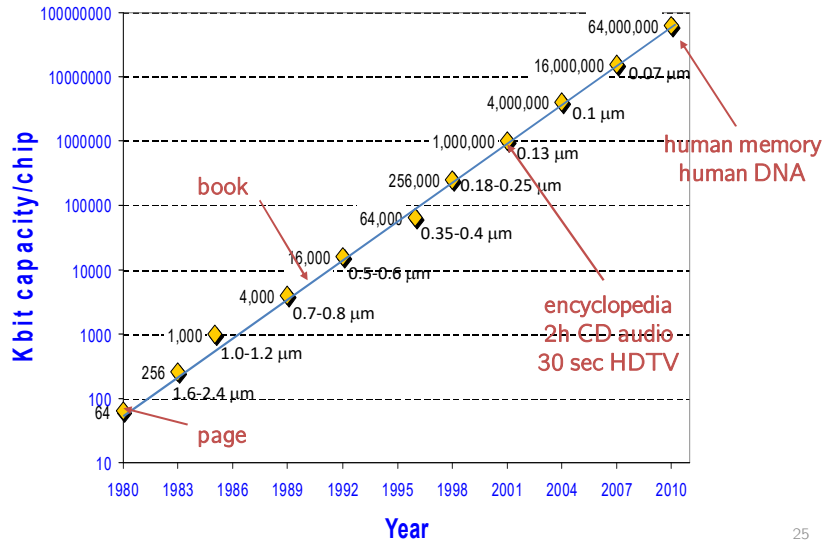


*for now

Image taken from: <https://www.pragcap.com/is-this-the-end-of-moores-law/>

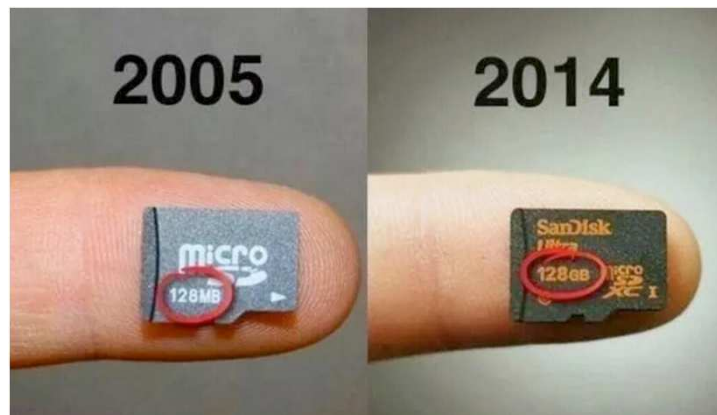
24

Evolution of DRAM capacity



25

Impressive “example:” Flash memory



What’s interesting about this?

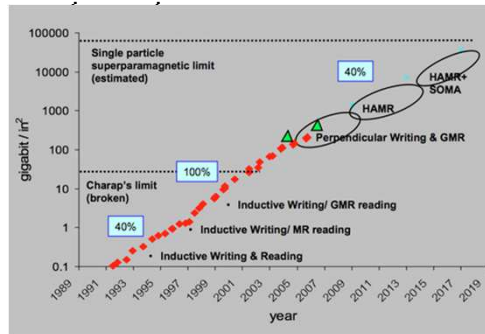
In 2017, we had 400GB!

Image taken from: <https://www.gsgtelco.com/2014/05/02/the-leap-in-memory-technology-from-2005-to-2014/>

26

Kryder's Law

- 10 years have about 6.66x 18 months
- Moore's law only predicts $2^{(6.66)} \approx 101$
- But storage density increased 1000x in 1



Images taken from: <https://www.gsgetelco.com/2014/05/02/the-leap-in-memory-technology-from-2005-to-2014/>, <http://blog.dshr.org/2016/05/talk-at-seagate.html>

27

Power dissipation

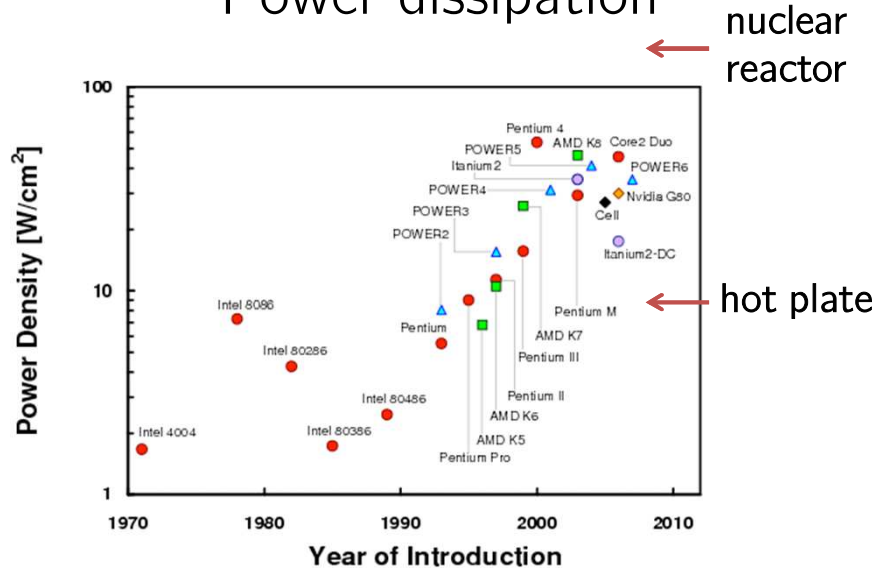


Image taken from: <http://celsiainc.com/blog-btx-desktop-pcs-a-thermally-superior-system-design-that-failed-horribly/>

28

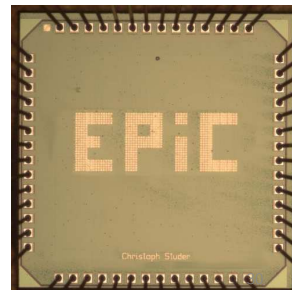
Can we master these challenges?

- Moore's Law is slowing down, demands for more data and processing still increasing
- Need to design increasingly complex ICs but we also have to ensure they work 100%
- Require denser and faster memories
- Circuits must be low-power
- This class will teach you the foundations to find solutions to these challenges!

29

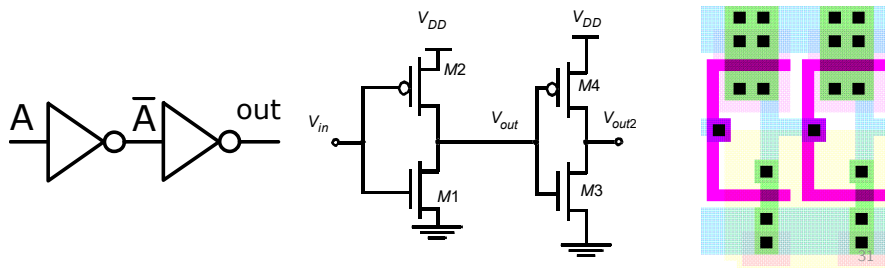
Course goals

- Know how to design basic building blocks
- Learn to develop digital ICs across several layers of hierarchy via **abstraction**
- Hands-on experience with state-of-the-art software: **Cadence Virtuoso**
- Develop strong intuition
- Most important: **enjoy VLSI design!**



Main focus: Full-custom design

- High-performance or “high-volume” ICs
 - Example: flagship Intel microprocessors
 - Fundamentals for computer architects
 - Used in data converters (DACs/ADCs)
 - RF engineers



Advantages and disadvantages

- Full-custom design gives full control over all possible design parameters:
 - (potentially) lower power
 - (potentially) lower area
 - (potentially) higher throughput
 - (potentially) higher yield
 - (potentially) more fun
- Drawback:
 - A lot of (tedious) work
 - Difficult to quickly develop large designs
 - Design tools are getting better and better

Why aren't we just using CAD tools?

- Ex.: Synopsys DC enables the design of high-performance complex VLSI designs
 - You write Verilog/VHDL and compile
 - Results are hard to beat by hand (especially for inexperienced users)

Even with such tools, you must understand the fundamentals

33

Why? – an academic perspective

- Top journals/conferences in solid-state circuits and VLSI require fabricated chips
- ISSCC, the flagship conference, favors designs with transistor-level schematics

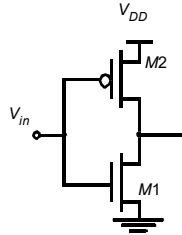


34

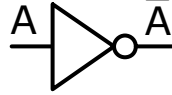
There are different abstraction layers



layout view



schematic view



logic symbol

A	NOT A
0	1
1	0

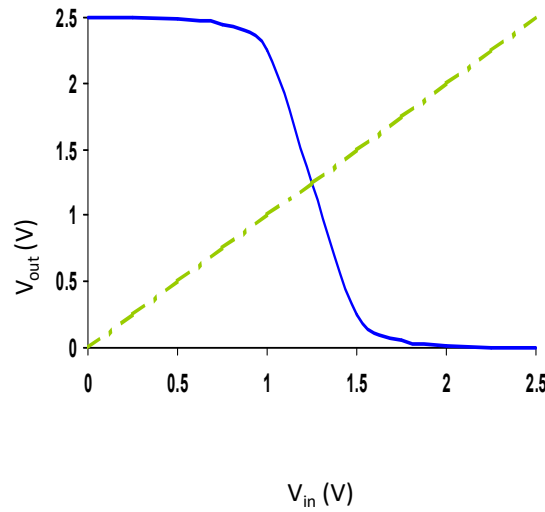
truth table

- We are going to use all these abstractions

35

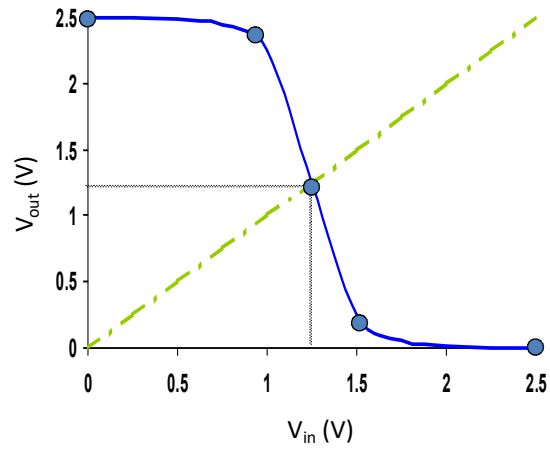
Wait, there is more!

- Voltage transfer characteristic (VTC)



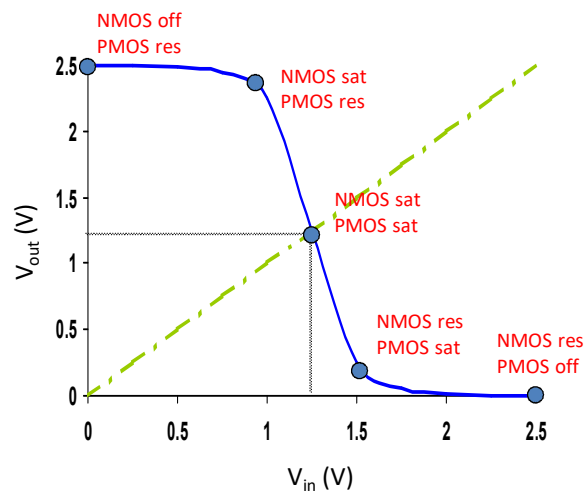
36

MOS operating regimes



37

MOS operating regimes (cont'd)



38